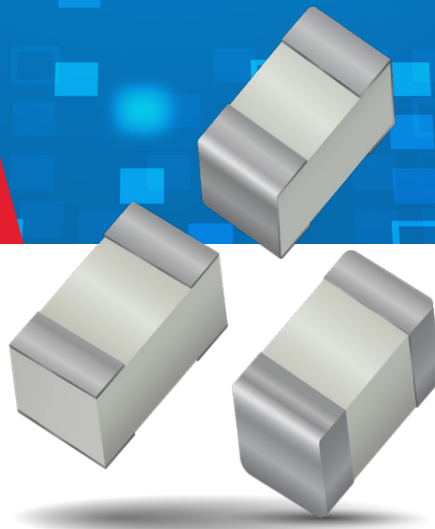




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# Q-BRIDGE THERMAL CONDUCTOR



## GENERAL DESCRIPTION

KYOCERA AVX's new Q-Bridge Thermal Conductor is manufactured with the highest quality materials for reliable and repeatable performance providing a cost effective thermal management solution. These devices are constructed with Aluminum Nitride (AlN) or Beryllium Oxide (BeO) and are available in standard EIA form factors. Q-Bridge provides the designer with the ability to manage thermal conditions by directing heat to a thermal ground plane, heat sink or any other specific thermal point of interest. The inherently low capacitance makes this device virtually transparent at RF/microwave frequencies. This device has the added benefit of offering additional layers of protection to adjacent components from hot spot thermal loads. Q-Bridge provides the benefit of increased overall circuit reliability. KYOCERA AVX's Q-Bridge is manufactured using one-piece construction, providing a RoHS compliant SMT package that is fully compatible with high speed automated pick-and-place processing. It is available in multiple different EIA case sizes. Custom configurations are also available.

## APPLICATIONS

- » High Thermal Conductivity
- » Low Thermal Resistance
- » Low Capacitance
- » Increases Circuit Reliability
- » RoHS Compliant
- » More efficient thermal management

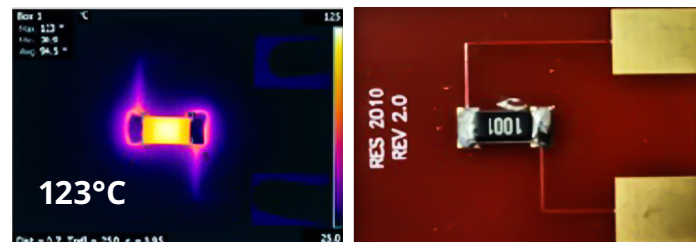
## FEATURES

- » GaN Power Amplifiers
- » High RF Power Amplifiers
- » Filters
- » Synthesizers
- » Industrial Computers
- » Switch Mode Power Supplies
- » Pin & Laser Diodes

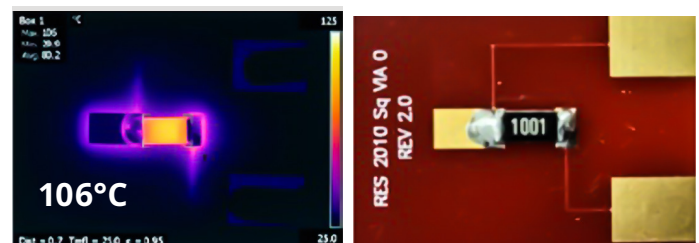
## FUNCTIONAL APPLICATIONS

- » Between active device and adjacent ground planes
- » Specific contact pad to case
- » Contact pad to contact pad
- » Direct component contact to via pad or trace
- » Edges fully metalized

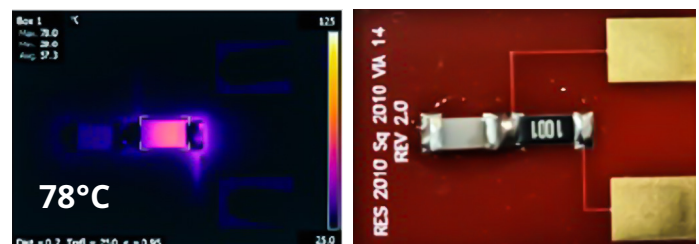
## Q-BRIDGE THERMAL TESTS INDICATE THE HEAT DISSIPATION OUTCOMES



Resistor without any added heat removal, power output 841mW



Resistor with added metal heat sink, power output 841mW



Resistor with added 2010 Q-Bridge, power output 841mW



# Q-BRIDGE THERMAL CONDUCTOR



## PART NUMBER INFORMATION

**QB 0603 A 25 W Y T**

**Q-Bridge** ————

**Case Size** ————  
Please see 'Case Size' Column of Typical Characteristics Table Below

**Substrate** ————  
A = AlN  
B = BeO

**Thickness (mils)** ————  
The above part number refers to a Q-Bridge, (EIA case size 0603), Aluminum Nitride Substrate, Thickness 25 mils., Style W, Y Termination (Silver Platinum Non-Magnetic Termination), with Tape and Reel Packaging.

**Packaging**  
T = 1000pcs., 7" reel  
T\500 = 500pcs., 7" reel  
C = Matrix Tray

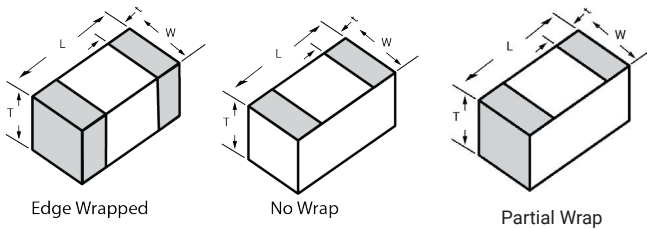
**Termination**  
Y = Silver Platinum, Non-Magnetic Termination  
S = Silver over Magnetic Termination  
J\* = 60Sn/40Pb Solder Plated over Nickel over Silver Platinum  
T = Tin plated over Nickel over Silver Platinum

**Style**  
W = Edge Wrap  
E = No Wrap

**RoHS COMPLIANT**

\* Not RoHS Compliant Consult factory for other termination options e.g., tin plate and solder plate

## MECHANICAL CONFIGURATIONS



## TERMINATION MATERIALS

Termination Code	Termination Materials	
T	Tin plated over Nickel over Silver Platinum	RoHS Compliant
Y	Silver Platinum Non-Magnetic Termination	RoHS Compliant
S	Silver over Magnetic Termination	RoHS Compliant
J	Solder Plated over Nickel over Silver Platinum	Not RoHS Compliant

## TYPICAL CHARACTERISTICS Inches (mm)

Case Size	Length (L)	Width (W)	Thickness (T)	Terminal (t)	Voltage Rating (V)	Thermal Resistance (°C/W)		Thermal Conductivity (mW/°C)		Available Configurations	
						AlN	BeO	AlN	BeO	Style	Termination
0302	.030 ± .002 (.77 ± .051)	.020 ± .002 (0.51 ± .051)	0.02 (0.51 ± .05)	0.01 (0.25)	100	19	12	53	81	W	Y, T, J
										E	S
0402	.040 ± .002 (1.02 ± .051)	.020 ± .002 (0.51 ± .051)	0.02 (0.51 ± .05)	0.01 (0.25)	200	25	16	40	61	W	Y, T, J
										E	S
0505	.050 ± .002 (1.27 ± .051)	.050 ± .002 (1.27 ± .051)	25 (0.64 ± .05)	0.015 (0.38)	250	10	7	100	153	W	Y, T, J
										E	S
0603	.060 ± .002 (1.52 ± .051)	.030 ± .002 (.77 ± .051)	0.025 (0.64 ± .05)	0.015 (0.38)	250	20	13	50	76	W	Y, T, J
										E	S
0805	.080 ± .002 (2.03 ± .051)	.050 ± .002 (1.27 ± .051)	0.04 (1.02 ± .05)	0.02 (0.51)	250	10	7	100	153	W	Y, T, J
										E	S
1005	.100 ± .002 (2.54 ± .051)	.050 ± .002 (1.27 ± .051)	0.04 (1.02 ± .05)	0.02 (0.51)	500	13	8	77	122	W	Y, T, J
										E	S
1020	.100 ± .002 (2.54 ± .051)	.200 ± .002 (5.08 ± .051)	0.04 (1.02 ± .05)	0.02 (0.51)	500	3	2	320	508	W	Y, T, J
										E	S
1111	.110 ± .002 (2.79 ± .051)	.110 ± .002 (2.79 ± .051)	0.04 (1.02 ± .05)	0.02 (0.51)	500	7	4	153	240	W	Y, T, J
										E	S
2010	.195 ± .010 (4.95 ± .254)	.095 ± .010 (2.41 ± .254)	0.06 (1.52 ± .05)	0.03 (0.77)	2000	10	6	100	159	W	S
										E	S
2525	.240 ± .010 (6.10 ± .254)	.250 ± .010 (6.35 ± .254)	0.06 (1.52 ± .05)	0.04 (1.02)	3000	4	3	240	380	W	S
										E	S
3725	.370 ± .010 (9.40 ± .254)	.245 ± .010 (6.22 ± .254)	0.06 (1.52 ± .05)	0.05 (1.27)	4000	6	4	160	254	W	S
										E	S
3737	.365 ± .010 (9.27 ± .254)	.375 ± .010 (9.53 ± .254)	0.06 (1.52 ± .05)	0.05 (1.27)	4000	4	3	240	380	W	S
										E	S